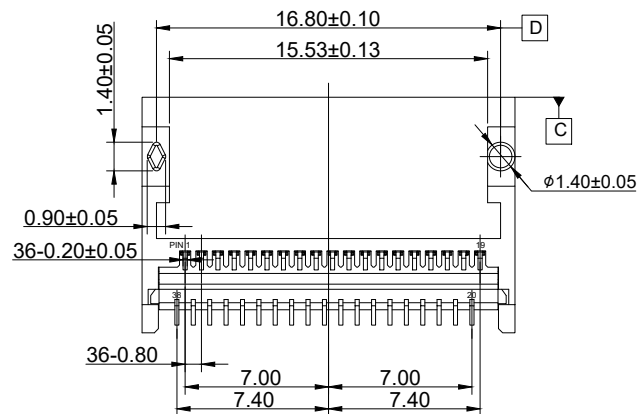
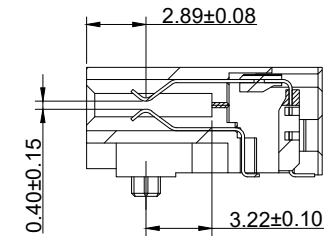
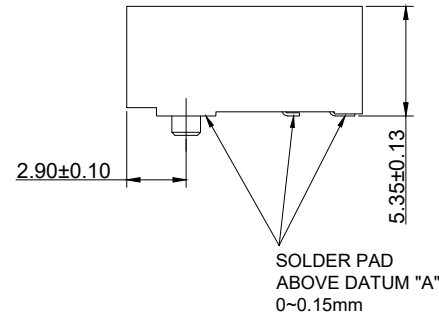
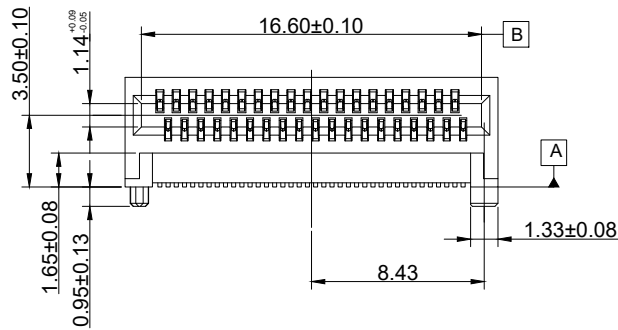
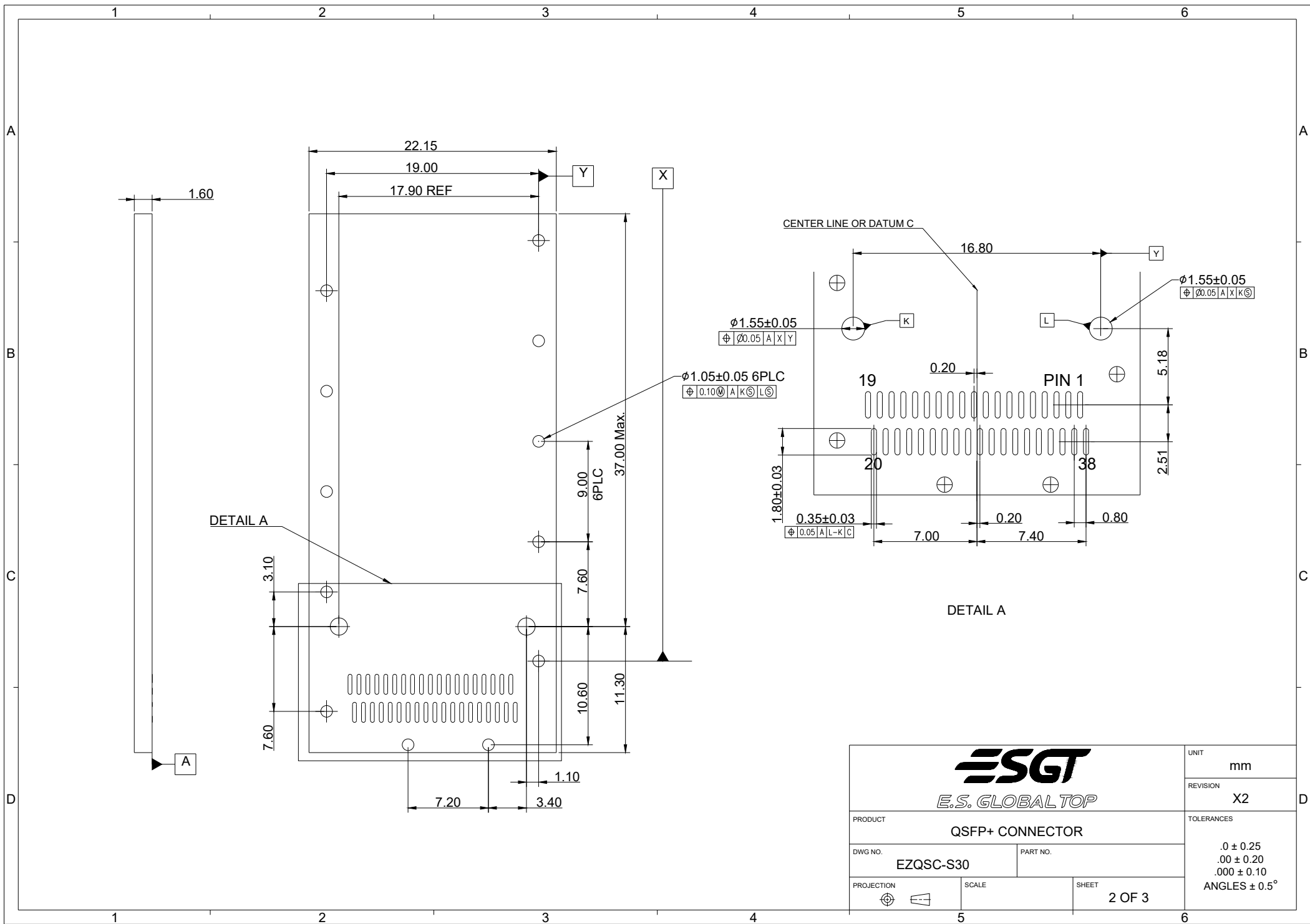




NOTES:
 HOUSING : LCP UL94V-0 BLACK
 TERMINAL : NICKEL COPPER ALLOY
 PLATING : Au PLATING 0.38µm Min.
 OVER Ni PLATING 2.54µm Min.
 FOR CONTACT AREA
 MATTE Sn PLATING 5.09~2.54µm Min.
 OVER Ni PLATING 2.54µm Min.
 FOR SOLDER AREA

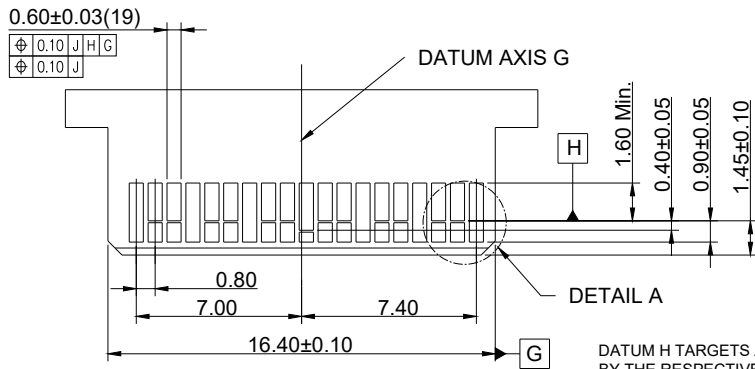
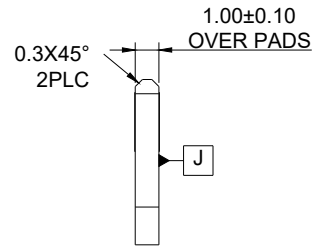
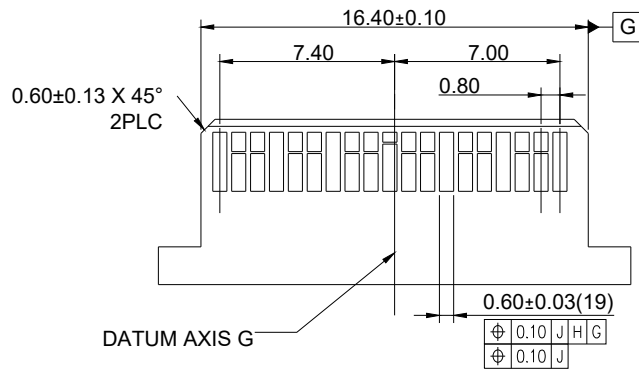
CONTACT CURRENT RATING : 0.5 AMP
 VOLTAGE RATING : 30V AC
 CONTACT RESISTANCE : 40 mΩ Max.
 DIELECTRIC WITHSTANDING VOLTAGE : 300V DC
 OPERATION TEMPERATURE : -20°C~85°C



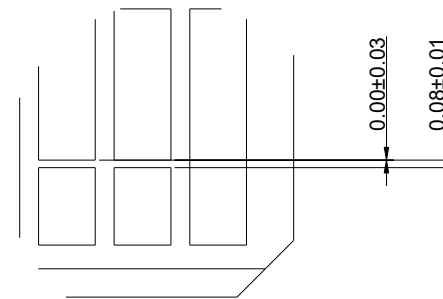
		UNIT	mm
		REVISION	X2
PRODUCT		QSFP+ CONNECTOR	
DWG NO.	EZQSC-S30	PART NO.	
PROJECTION		SCALE	SHEET
		1 OF 3	
		TOLERANCES .0 ± 0.25 .00 ± 0.20 .000 ± 0.10 ANGLES ± 0.5°	



 E.S. GLOBALTOP		UNIT	mm
		REVISION	X2
PRODUCT		TOLERANCES	
QSFP+ CONNECTOR		.0 ± 0.25	
DWG NO.	PART NO.	.00 ± 0.20	
EZQSC-S30		.000 ± 0.10	
PROJECTION	SCALE	SHEET	ANGLES ± 0.5°
		2 OF 3	



DATUM H TARGETS ARE DEFINED BY THE RESPECTIVE PAD CENTERLINES AND THE LEADING EDGE OF THE TARGET PADS



DETAIL A

		UNIT	mm
		REVISION	X2
PRODUCT		QSFP+ CONNECTOR	
DWG NO.	PART NO.	TOLERANCES .0 ± 0.25 .00 ± 0.20 .000 ± 0.10 ANGLES ± 0.5°	
EZQSC-S30			
PROJECTION	SCALE		
		SHEET	3 OF 3